

TLGE1005B

Features

3.2 (L) x 2.4 (W) x 2.4 (H) mm
 2 mm lens top type
 InGaAlP LED
 Reflow soldering is possible
 Standard embossed taping 4 mm pitch : T03 (1000 pcs/reel)

Applications

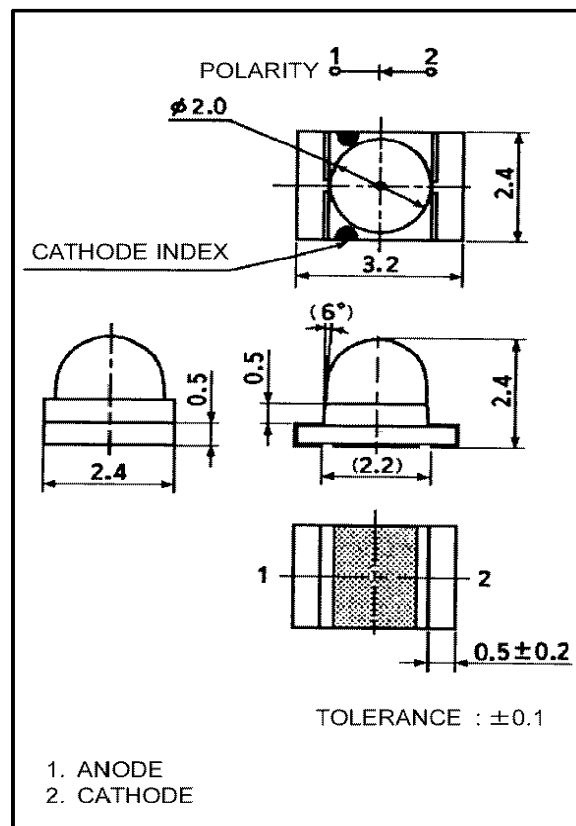
High-output backlighting source
 Battery-powered equipment
 Message boards
 Portable devices
 Computer peripherals

Maximum Ratings (Ta=25°C)

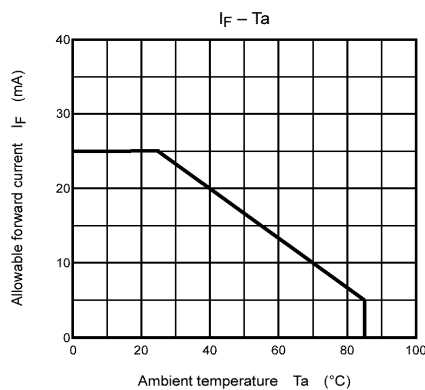
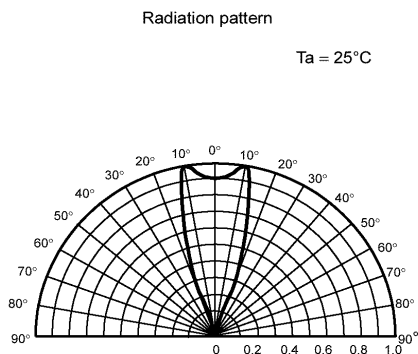
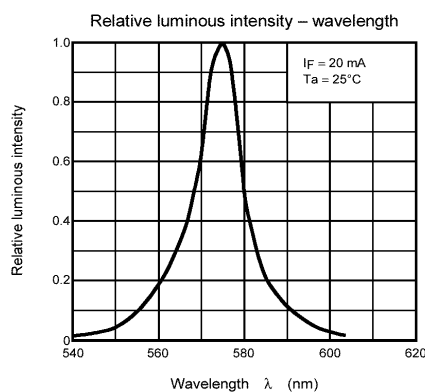
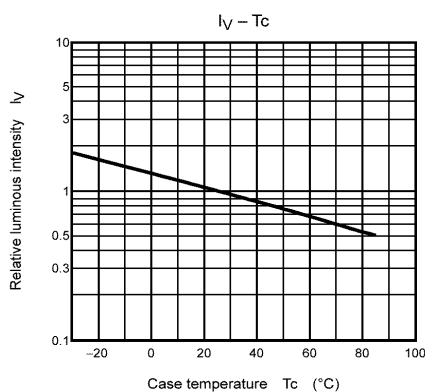
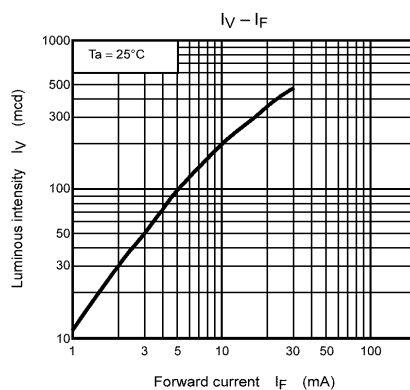
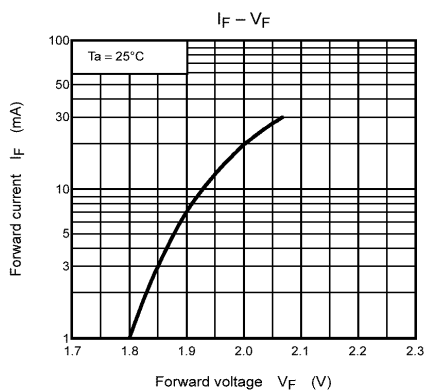
Characteristic	Symbol	Max.	Unit
Forward Current	I _F	25	mA
Reverse Voltage	V _R	4.00	V
Power Dissipation	P _D	60.00	mW
Operating Temperature	T _{opr}	-40 ~ 85	°C
Storage Temperature	T _{stg}	-40 ~ 100	°C
Soldering Temperature	T _{sol}	260	°C
Soldering Time	—	for 3 sec. max	—

Opto-Electrical Characteristics (Ta=25°C)

Characteristic	Symbol	Test Condition	Min	Typ	Max	Unit
Forward Voltage	V _F	I _F =20mA	—	2.00	2.40	V
Reverse Current	I _R	V _R =4V	—	—	50	μA
Luminous Intensity	I _v	I _F =20mA	153.00	350.00	—	mcd
Viewing Angle	2θ ^{1/2}	—	—	45°	—	deg.
Peak Wavelength	λ _p	I _F =20mA	—	574	—	nm
Dominant Wavelength	λ _d	I _F =20mA	—	571	—	nm
Spectral Line Half Width	Δλ	I _F =20mA	—	11	—	nm



TLGE1005B Graphs



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